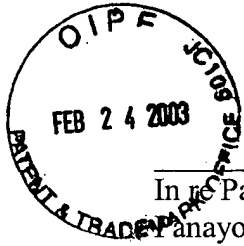


Docket No.: YOR920000578US1
(PATENT)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Panayotis Andricacos, et al

Application No.: 09/760,884

Filed: January 17, 2001

For: TUNGSTEN ENCAPSULATED COPPER
INTERCONNECTIONS USING
ELECTROPLATING

Group Art Unit: 1741

Examiner: Smith Hicks

3/A
W.M.
3/5/03

AMENDMENT

Commissioner of Patents and Trademarks
Washington, DC 20231

Dear Sir:

This is in response to the Office Action dated November 22, 2002 (Paper No. 2).

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